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Patent  
259/079  
P01-0015

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

**KENNY, Michael et al.**

**Serial No.: 09/925,884**

**Filed: August 6, 2001**

**For: Process And Apparatus For Treating  
A Workpiece Such As A Semiconductor  
Wafer**

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) **Group Art Unit: 1746**  
)

) **Examiner: Not yet assigned**  
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TRANSMITTAL OF FORMAL DRAWINGS

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Transmitted herewith for filing in the above-referenced application are formal drawings

(11 sheets).

Respectfully submitted,  
LYON & LYON LLP

Dated: November 15, 2001

By:

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(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

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